The 3842-2842-3843-2843 series are high performance fixed frequency current mode controllers. They are specifically designed for Off−Line and DC−DC converter applications offering the designer a cost−effective solution with minimal external components. These integrated circuits feature a trimmed oscillator for precise duty cycle control, a temperature compensated reference, high gain error amplifier, current sensing comparator, and a high current totem pole output ideally suited for driving a power MOSFET.
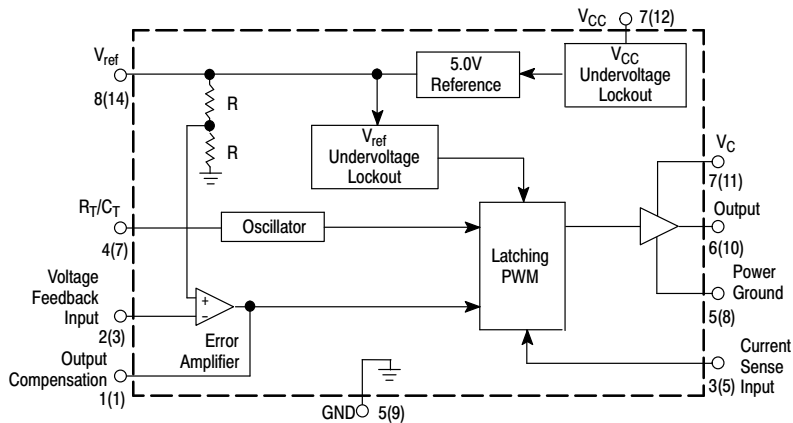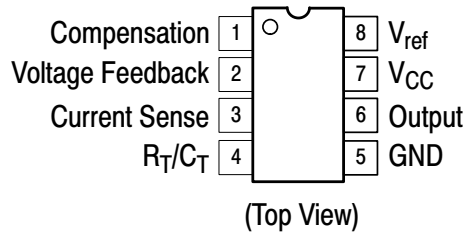
Also included are protective features consisting of input and reference undervoltage lockouts each with hysteresis, cycle−by−cycle current limiting, programmable output deadtime, and a latch for single pulse metering.

The 3842-2842 has UVLO thresholds of 16 V (on) and 10 V (off), ideally suited for off−line converters. The 3843-2843 is tailored for lower voltage applications having UVLO thresholds of 8.5 V (on) and 7.6 V (off).

**Features**

- Trimmed Oscillator for Precise Frequency Control
- Oscillator Frequency Guaranteed at 250 kHz
- Current Mode Operation to 500 kHz
- Automatic Feed Forward Compensation
- Latching PWM for Cycle−By−Cycle Current Limiting
- Internally Trimmed Reference with Undervoltage Lockout
- High Current Totem Pole Output
- Undervoltage Lockout with Hysteresis
- Low Startup and Operating Current
- This is a Pb−Free and Halide−Free Device

## PIN CONNECTIONS



(Top View)



**Figure 1. Simplified Block Diagram**

## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|---|---|---|
| Bias and Driver Voltages (Zero Series Impedance, see also Total Device spec) | $V_{CC}$, $V_C$ | 30 | V |
| Total Power Supply and Zener Current | ($I_{CC}$ + $I_Z$) | 30 | mA |
| Output Current, Source or Sink | $I_O$ | 1.0 | A |
| Output Energy (Capacitive Load per Cycle) | W | 5.0 | $\mu$J |
| Current Sense, Voltage Feedback, $V_{ref}$ and Rt/Ct Inputs | $V_{in}$ | – 0.3 to + 5.5 | V |
| Compensation | $V_{comp}$ | – 0.3 to + 7.2 | V |
| Output | $V_o$ | – 0.3 to $V_{CC}$ or $V_C$ + 0.3 | V |
| Error Amp Output Sink Current | $I_O$ | 10 | mA |
| Power Dissipation and Thermal Characteristics<br>  D1 Suffix, Plastic Package, SOIC–8 Case 751<br>    Maximum Power Dissipation @ $T_A$ = 25°C<br>    Thermal Resistance, Junction–to–Air<br>  N Suffix, Plastic Package, Case 626<br>    Maximum Power Dissipation @ $T_A$ = 25°C<br>    Thermal Resistance, Junction–to–Air | $P_D$<br>$R_{\theta JA}$<br><br>$P_D$<br>$R_{\theta JA}$ | 702<br>178<br><br>1.25<br>100 | mW<br>°C/W<br><br>W<br>°C/W |
| Operating Junction Temperature | $T_J$ | +150 | °C |
| Operating Ambient Temperature<br><br>                          3842-3843-2842-2843 | $T_A$ | 0 to 70<br>– 25 to + 85 | °C |
| Storage Temperature Range | $T_{stg}$ | – 65 to +150 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1.  This device series contains ESD protection and exceeds the following tests:
      Human Body Model 4000 V per JEDEC Standard JESD22-A114B
      Machine Model Method 200 V per JEDEC Standard JESD22-A115-A
2.  This device contains latch-up protection and exceeds 100 mA per JEDEC Standard JESD78

**ELECTRICAL CHARACTERISTICS** ($V_{CC}$ = 15 V [Note 3], $R_T$ = 10 k, $C_T$ = 3.3 nF. For typical values $T_A$ = 25°C, for min/max values $T_A$ is the operating ambient temperature range that applies [Note 4], unless otherwise noted.)

| Characteristics | Symbol | 2842 2843 | | | 3842 3843 | | | Unit |
|---|---|---|---|---|---|---|---|---|
| | | Min | Typ | Max | Min | Typ | Max | |
| **REFERENCE SECTION** | | | | | | | | |
| Reference Output Voltage ($I_O$ = 1.0 mA, $T_J$ = 25°C) | $V_{ref}$ | 4.95 | 5.0 | 5.05 | 4.9 | 5.0 | 5.1 | V |
| Line Regulation ($V_{CC}$ = 12 V to 25 V) | $Reg_{line}$ | – | 2.0 | 20 | – | 2.0 | 20 | mV |
| Load Regulation ($I_O$ = 1.0 mA to 20 mA) | $Reg_{load}$ | – | 3.0 | 25 | – | 3.0 | 25 | mV |
| Temperature Stability | $T_S$ | – | 0.2 | – | – | 0.2 | – | mV/°C |
| Total Output Variation over Line, Load, and Temperature<br>2842<br>2843 | $V_{ref}$ | 4.9<br>4.82 | –<br>– | 5.1<br>5.18 | 4.82 | – | 5.18 | V |
| Output Noise Voltage (f = 10 Hz to 10 kHz, $T_J$ = 25°C) | $V_n$ | – | 50 | – | – | 50 | – | μV |
| Long Term Stability ($T_A$ = 125°C for 1000 Hours) | S | – | 5.0 | – | – | 5.0 | – | mV |
| Output Short Circuit Current | $I_{SC}$ | – 30 | – 85 | –180 | – 30 | – 85 | –180 | mA |
| **OSCILLATOR SECTION** | | | | | | | | |
| Frequency<br>$T_J$ = 25°C<br>$T_A$ = $T_{low}$ to $T_{high}$<br>$T_J$ = 25°C ($R_T$ = 6.2 k, $C_T$ = 1.0 nF) | $f_{OSC}$ | 49<br>48<br>225 | 52<br>–<br>250 | 55<br>56<br>275 | 49<br>48<br>225 | 52<br>–<br>250 | 55<br>56<br>275 | kHz |
| Frequency Change with Voltage ($V_{CC}$ = 12 V to 25 V) | $\Delta f_{OSC}/\Delta V$ | – | 0.2 | 1.0 | – | 0.2 | 1.0 | % |
| Frequency Change with Temperature, $T_A$ = $T_{low}$ to $T_{high}$ | $\Delta f_{OSC}/\Delta T$ | – | 1.0 | – | – | 0.5 | – | % |
| Oscillator Voltage Swing (Peak–to–Peak) | $V_{OSC}$ | – | 1.6 | – | – | 1.6 | – | V |
| Discharge Current ($V_{OSC}$ = 2.0 V)<br>$T_J$ = 25°C, $T_A$ = $T_{low}$ to $T_{high}$<br>2842 3842<br>2843  3843 | $I_{dischg}$ | 7.8<br>7.5<br>– | 8.3<br>–<br>– | 8.8<br>8.8<br>– | 7.8<br>7.6<br>7.2 | 8.3<br>–<br>– | 8.8<br>8.8<br>8.8 | mA |
| **ERROR AMPLIFIER SECTION** | | | | | | | | |
| Voltage Feedback Input ($V_O$ = 2.5 V)　　2842<br>2843 | $V_{FB}$ | 2.45<br>2.42 | 2.5<br>2.5 | 2.55<br>2.58 | 2.42 | 2.5 | 2.58 | V |
| Input Bias Current ($V_{FB}$ = 5.0 V) | $I_{IB}$ | – | – 0.1 | –1.0 | – | – 0.1 | – 2.0 | μA |
| Open Loop Voltage Gain ($V_O$ = 2.0 V to 4.0 V) | $A_{VOL}$ | 65 | 90 | – | 65 | 90 | – | dB |
| Unity Gain Bandwidth ($T_J$ = 25°C) | BW | 0.7 | 1.0 | – | 0.7 | 1.0 | – | MHz |
| Power Supply Rejection Ratio ($V_{CC}$ = 12 V to 25 V) | PSRR | 60 | 70 | – | 60 | 70 | – | dB |
| Output Current<br>Sink ($V_O$ = 1.1 V, $V_{FB}$ = 2.7 V)<br>Source ($V_O$ = 5.0 V, $V_{FB}$ = 2.3 V) | $I_{Sink}$<br>$I_{Source}$ | 2.0<br>– 0.5 | 12<br>–1.0 | –<br>– | 2.0<br>– 0.5 | 12<br>–1.0 | –<br>– | mA |
| Output Voltage Swing<br>High State ($R_L$ = 15 k to ground, $V_{FB}$ = 2.3 V)<br>Low State ($R_L$ = 15 k to $V_{ref}$, $V_{FB}$ = 2.7 V)<br>2842 3842<br>2843  3843 | $V_{OH}$<br>$V_{OL}$ | 5.0<br>–<br>– | 6.2<br>0.8<br>– | –<br>1.1<br>– | 5.0<br>–<br>– | 6.2<br>0.8<br>0.8 | –<br>1.1<br>1.2 | V |

3.  Adjust $V_{CC}$ above the Startup threshold before setting to 15 V.
4.  Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
    $T_{low}$ = 0°C for 3842,3843;  –25°C for 2842,2843; –40°C

**ELECTRICAL CHARACTERISTICS** ($V_{CC}$ = 15 V [Note 7], $R_T$ = 10 k, $C_T$ = 3.3 nF. For typical values $T_A$ = 25°C, for min/max values $T_A$ is the operating ambient temperature range that applies [Note 8], unless otherwise noted.)

| Characteristics | Symbol | 2842 2843 | | | 3842 3843 | | | Unit |
|---|---|---|---|---|---|---|---|---|
| | | Min | Typ | Max | Min | Typ | Max | |
| **CURRENT SENSE SECTION** | | | | | | | | |
| Current Sense Input Voltage Gain (Notes 5 and 6) | $A_V$ | | | | | | | V/V |
|     2843 2842  3842  3843 | | 2.85 – | 3.0 – | 3.15 – | 2.85 2.85 | 3.0 3.0 | 3.15 3.25 | |
| Maximum Current Sense Input Threshold (Note 5) | $V_{th}$ | | | | | | | V |
|     2843 2842  3842  3843 | | 0.9 – | 1.0 – | 1.1 – | 0.9 0.85 | 1.0 1.0 | 1.1 1.1 | |
| Power Supply Rejection Ratio ($V_{CC}$ = 12 V to 25 V, Note 5) | PSRR | – | 70 | – | – | 70 | – | dB |
| Input Bias Current | $I_{IB}$ | – | – 2.0 | –10 | – | – 2.0 | –10 | µA |
| Propagation Delay (Current Sense Input to Output) | $t_{PLH(In/Out)}$ | – | 150 | 300 | – | 150 | 300 | ns |
| **OUTPUT SECTION** | | | | | | | | |
| Output Voltage | | | | | | | | V |
|   Low State  ($I_{Sink}$ = 20 mA) | $V_{OL}$ | – | 0.1 | 0.4 | – | 0.1 | 0.4 | |
|         ($I_{Sink}$ = 200 mA)    2843 2842 | | – | 1.6 | 2.2 | – | 1.6 | 2.2 | |
|                   3842  3843 | | – | – | – | – | 1.6 | 2.3 | |
|   High State  ($I_{Source}$ = 20 mA)  2843 2842 | $V_{OH}$ | 13 | 13.5 | – | 13 | 13.5 | – | |
|                   3842  3843 | | – | – | – | 12.9 | 13.5 | – | |
|       ($I_{Source}$ = 200 mA) | | 12 | 13.4 | – | 12 | 13.4 | – | |
| Output Voltage with UVLO Activated ($V_{CC}$ = 6.0 V, $I_{Sink}$ = 1.0 mA) | $V_{OL(UVLO)}$ | – | 0.1 | 1.1 | – | 0.1 | 1.1 | V |
| Output Voltage Rise Time ($C_L$ = 1.0 nF, $T_J$ = 25°C) | $t_r$ | – | 50 | 150 | – | 50 | 150 | ns |
| Output Voltage Fall Time ($C_L$ = 1.0 nF, $T_J$ = 25°C) | $t_f$ | – | 50 | 150 | – | 50 | 150 | ns |
| **UNDERVOLTAGE LOCKOUT SECTION** | | | | | | | | |
| Startup Threshold ($V_{CC}$) | $V_{th}$ | | | | | | | V |
|                     2843 2842 | | 15 | 16 | 17 | 14.5 | 16 | 17.5 | |
|                     3842  3843 | | 7.8 | 8.4 | 9.0 | 7.8 | 8.4 | 9.0 | |
| Minimum Operating Voltage After Turn–On ($V_{CC}$) | $V_{CC(min)}$ | | | | | | | V |
|                     2843 2842 | | 9.0 | 10 | 11 | 8.5 | 10 | 11.5 | |
|                     3842  3843 | | 7.0 | 7.6 | 8.2 | 7.0 | 7.6 | 8.2 | |
| **PWM SECTION** | | | | | | | | |
| Duty Cycle | | | | | | | | % |
|     Maximum  2843 2842  3842  3843 | $DC_{(max)}$ | 94 – | 96 – | – – | 94 93 | 96 96 | – – | |
|     Minimum | $DC_{(min)}$ | – | – | 0 | – | – | 0 | |
| **TOTAL DEVICE** | | | | | | | | |
| Power Supply Current | $I_{CC} + I_C$ | | | | | | | mA |
|     Startup  ($V_{CC}$ = 6.5 V for 3843  2843 | | – | 0.3 | 0.5 | – | 0.3 | 0.5 | |
|            $V_{CC}$ 14 V for 2842, BV) | | | | | | | | |
|     (Note 7) | | – | 12 | 17 | – | 12 | 17 | |
| Power Supply Zener Voltage ($I_{CC}$ = 25 mA) | $V_Z$ | 30 | 36 | – | 30 | 36 | – | V |

5. This parameter is measured at the latch trip point with $V_{FB}$ = 0 V.

6. Comparator gain is defined as: $A_V \dfrac{\Delta V \text{ Output Compensation}}{\Delta V \text{ Current Sense Input}}$

7. Adjust $V_{CC}$ above the Startup threshold before setting to 15 V.

8. Low duty cycle pulse techniques are used during test to maintain junction temperature as close to ambient as possible.
    $T_{low}$ = 0°C for 3842  3843; –25°C for 2842  2843; –40°C
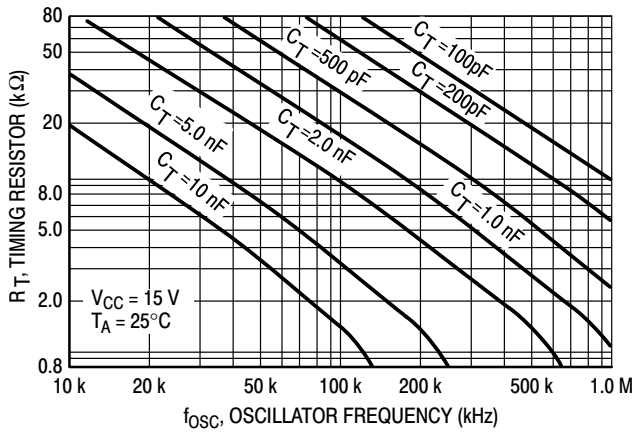
**Figure 2. Timing Resistor
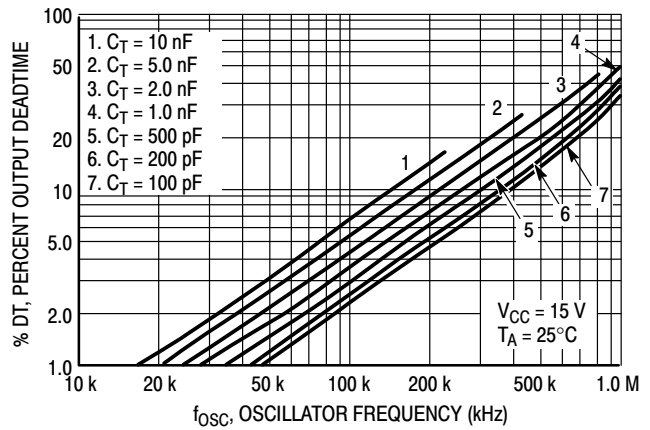versus Oscillator Frequency**



**Figure 3. Output Deadtime
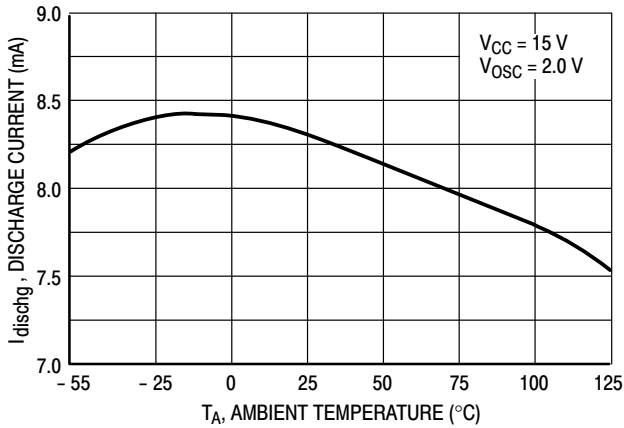versus Oscillator Frequency**



**Figure 4. Oscillator Discharge Current
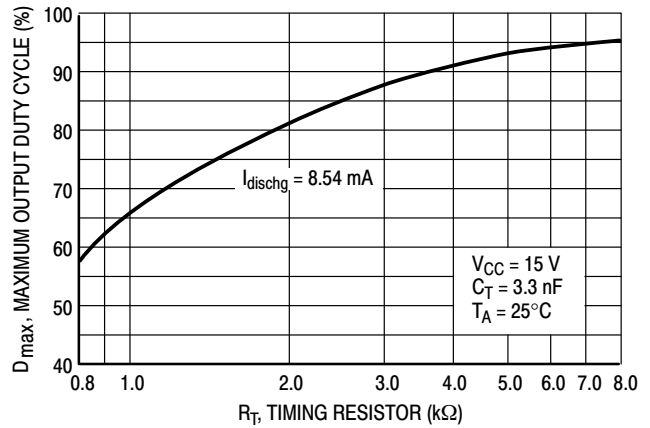versus Temperature**



**Figure 5. Maximum Output Duty Cycle
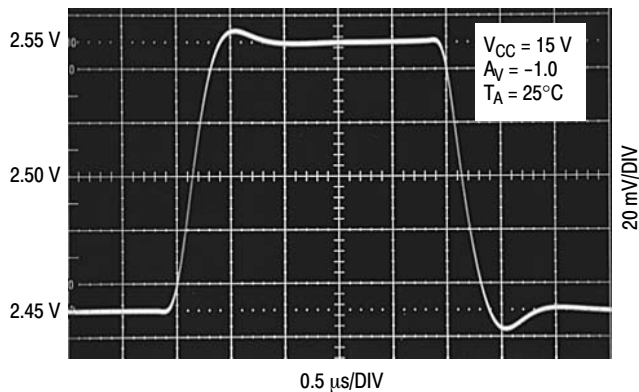versus Timing Resistor**



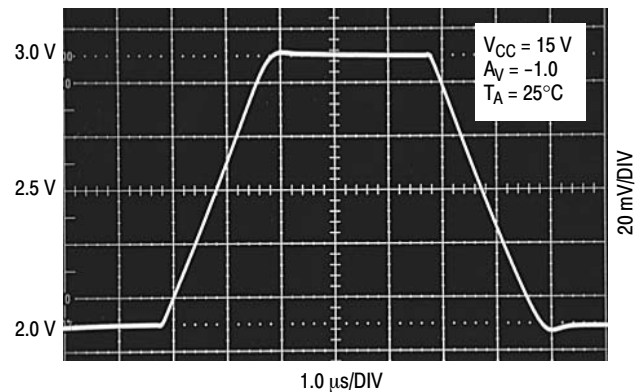**Figure 6. Error Amp Small Signal
Transient Response**
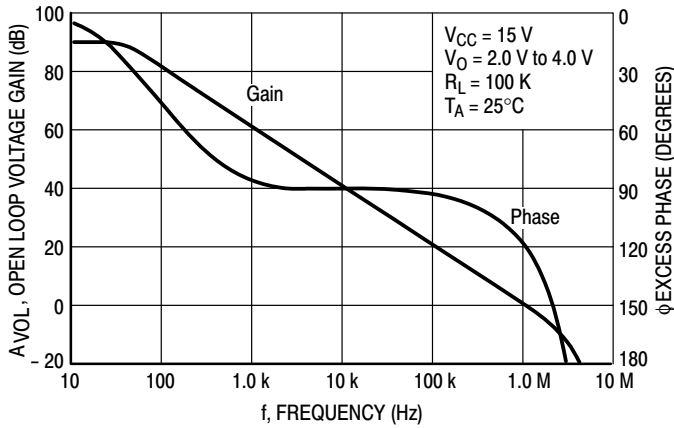


**Figure 7. Error Amp Large Signal
Transient Response**

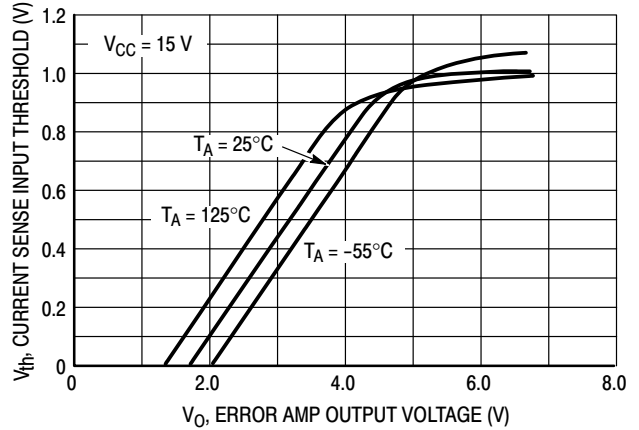**Figure 8. Error Amp Open Loop Gain and Phase versus Frequency**



**Figure 9. Current Sense Input Threshold versus Error Amp Output Voltage**
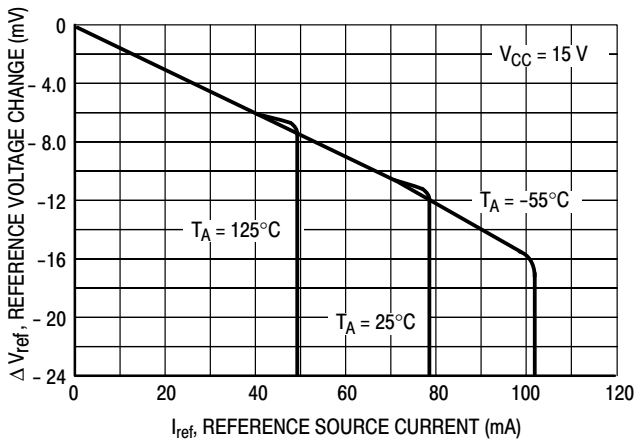


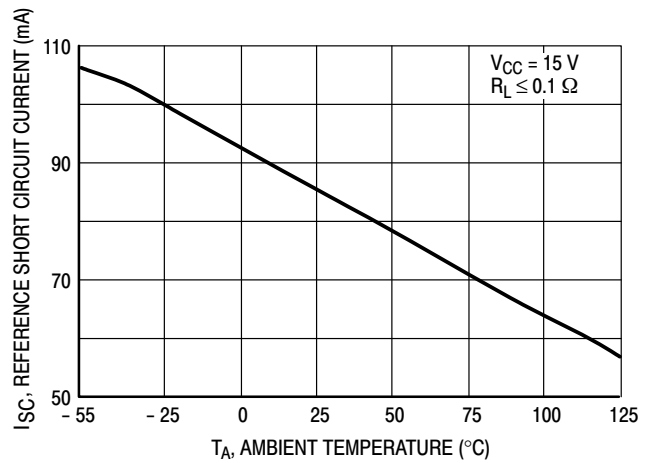**Figure 10. Reference Voltage Change versus Source Current**



**Figure 11. Reference Short Circuit Current versus Temperature**
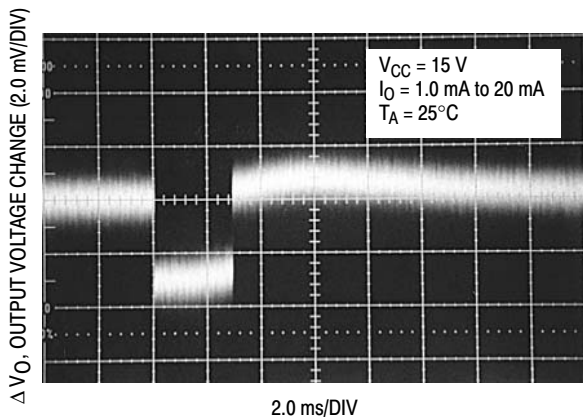


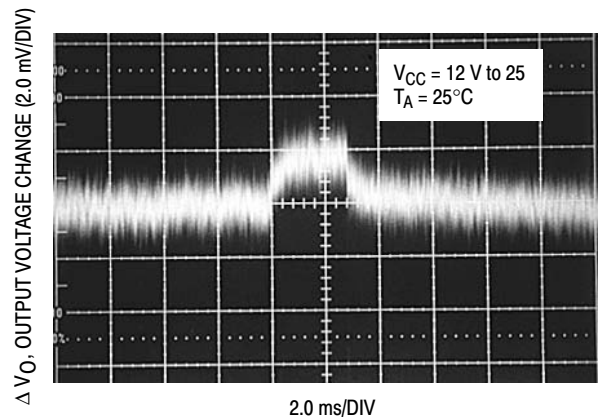**Figure 12. Reference Load Regulation**
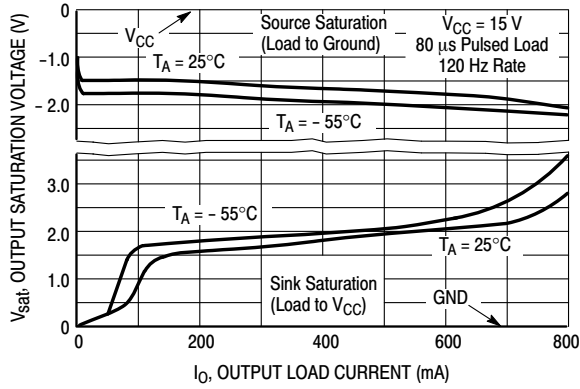


**Figure 13. Reference Line Regulation**

Figure 14. Output Saturation Voltage
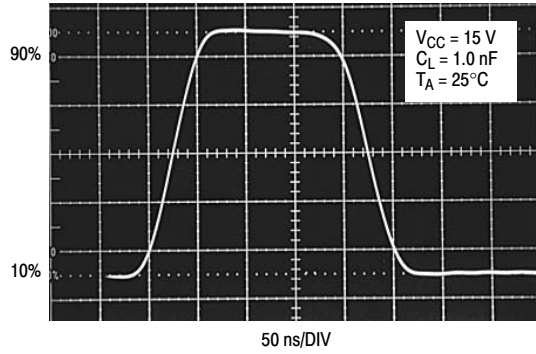versus Load Current
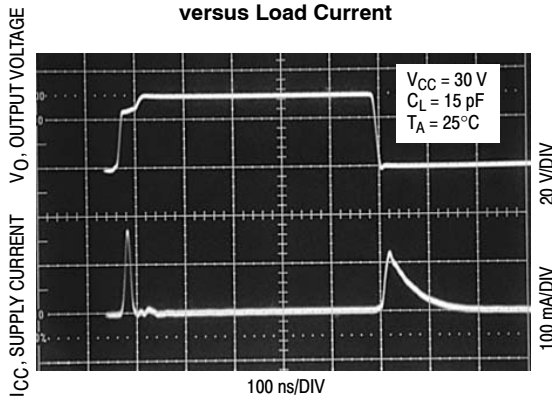


Figure 15. Output Waveform



Figure 16. Output Cross Conduction



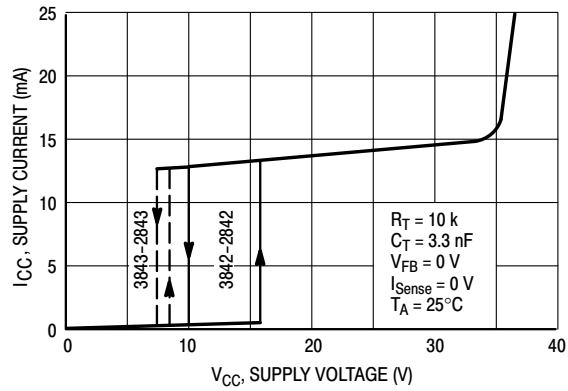Figure 17. Supply Current versus Supply Voltage

## PIN FUNCTION DESCRIPTION

| 8–Pin | 14–Pin | Function | Description |
|---|---|---|---|
| 1 | 1 | Compensation | This pin is the Error Amplifier output and is made available for loop compensation. |
| 2 | 3 | Voltage Feedback | This is the inverting input of the Error Amplifier. It is normally connected to the switching power supply output through a resistor divider. |
| 3 | 5 | Current Sense | A voltage proportional to inductor current is connected to this input. The PWM uses this information to terminate the output switch conduction. |
| 4 | 7 | $R_T/C_T$ | The Oscillator frequency and maximum Output duty cycle are programmed by connecting resistor $R_T$ to $V_{ref}$ and capacitor $C_T$ to ground. Operation to 500 kHz is possible. |
| 5 | | GND | This pin is the combined control circuitry and power ground. |
| 6 | 10 | Output | This output directly drives the gate of a power MOSFET. Peak currents up to 1.0 A are sourced and sunk by this pin. |
| 7 | 12 | $V_{CC}$ | This pin is the positive supply of the control IC. |
| 8 | 14 | $V_{ref}$ | This is the reference output. It provides charging current for capacitor $C_T$ through resistor $R_T$. |
| | 8 | Power Ground | This pin is a separate power ground return that is connected back to the power source. It is used to reduce the effects of switching transient noise on the control circuitry. |
| | 11 | $V_C$ | The Output high state ($V_{OH}$) is set by the voltage applied to this pin. With a separate power source connection, it can reduce the effects of switching transient noise on the control circuitry. |
| | 9 | GND | This pin is the control circuitry ground return and is connected back to the power source ground. |
| | 2,4,6,13 | NC | No connection. These pins are not internally connected. |

## Error Amplifier

A fully compensated Error Amplifier with access to the inverting input and output is provided. It features a typical DC voltage gain of 90 dB, and a unity gain bandwidth of 1.0 MHz with 57 degrees of phase margin (Figure 8). The non−inverting input is internally biased at 2.5 V and is not pinned out. The converter output voltage is typically divided down and monitored by the inverting input. The maximum input bias current is −2.0 μA which can cause an output voltage error that is equal to the product of the input bias current and the equivalent input divider source resistance.

The Error Amp Output (Pin 1) is provided for external loop compensation (Figure 33). The output voltage is offset by two diode drops ($\approx$1.4 V) and divided by three before it connects to the non−inverting input of the Current Sense Comparator. This guarantees that no drive pulses appear at the Output (Pin 6) when pin 1 is at its lowest state ($V_{OL}$). This occurs when the power supply is operating and the load is removed, or at the beginning of a soft−start interval (Figures 25, 26). The Error Amp minimum feedback resistance is limited by the amplifier's source current (0.5 mA) and the required output voltage ($V_{OH}$) to reach the comparator's 1.0 V clamp level:

$$R_{f(min)} \approx \frac{3.0 \,(1.0 \text{ V}) + 1.4 \text{ V}}{0.5 \text{ mA}} = 8800 \,\Omega$$

## Current Sense Comparator and PWM Latch

The 3842, 3843 operate as a current mode controller, whereby output switch conduction is initiated by the oscillator and terminated when the peak inductor current reaches the threshold level established by the Error Amplifier Output/Compensation (Pin 1). Thus the error signal controls the peak inductor current on a cycle−by−cycle basis. The Current Sense Comparator PWM Latch configuration used ensures that only a single pulse appears at the Output during any given oscillator cycle. The inductor current is converted to a voltage by inserting the ground−referenced sense resistor $R_S$ in series with the source of output switch Q1. This voltage is monitored by the Current Sense Input (Pin 3) and compared to a level derived from the Error Amp Output. The peak inductor current under normal operating conditions is controlled by the voltage at pin 1 where:

$$I_{pk} = \frac{V_{(Pin\ 1)} - 1.4 \text{ V}}{3 \, R_S}$$

Abnormal operating conditions occur when the power supply output is overloaded or if output voltage sensing is lost. Under these conditions, the Current Sense Comparator threshold will be internally clamped to 1.0 V. Therefore the maximum peak switch current is:

$$I_{pk(max)} = \frac{1.0 \text{ V}}{R_S}$$

When designing a high power switching regulator it becomes desirable to reduce the internal clamp voltage in order to keep the power dissipation of $R_S$ to a reasonable level. A simple method to adjust this voltage is shown in Figure 24. The two external diodes are used to compensate the internal diodes, yielding a constant clamp voltage over temperature. Erratic operation due to noise pickup can result if there is an excessive reduction of the $I_{pk(max)}$ clamp voltage.

A narrow spike on the leading edge of the current waveform can usually be observed and may cause the power supply to exhibit an instability when the output is lightly loaded. This spike is due to the power transformer interwinding capacitance and output rectifier recovery time. The addition of an RC filter on the Current Sense Input with a time constant that approximates the spike duration will usually eliminate the instability (refer to Figure 28).
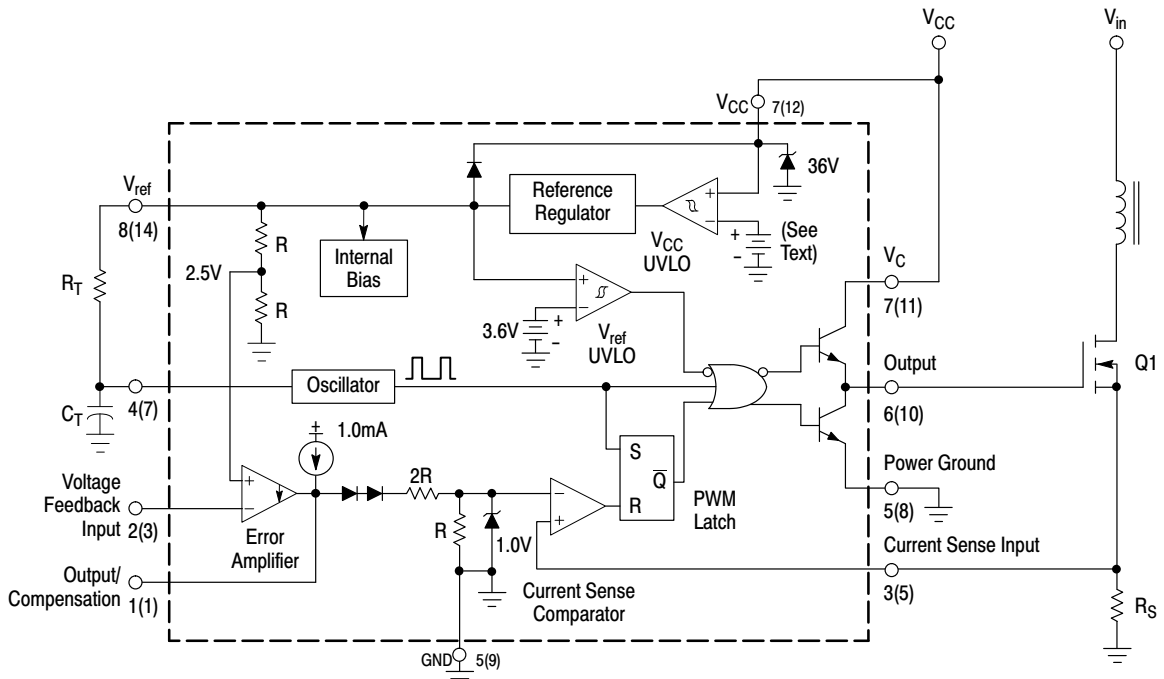
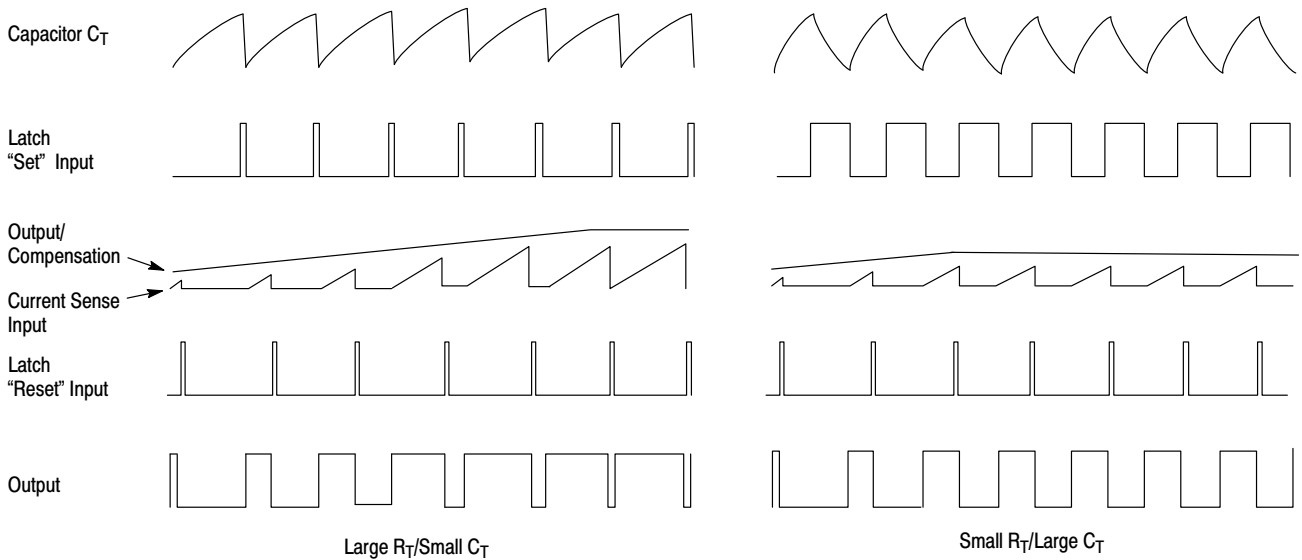**Figure 19. Representative Block Diagram**



**Figure 20. Timing Diagram**

**Undervoltage Lockout**

Two undervoltage lockout comparators have been incorporated to guarantee that the IC is fully functional before the output stage is enabled. The positive power supply terminal ($V_{CC}$) and the reference output ($V_{ref}$) are each monitored by separate comparators. Each has built−in hysteresis to prevent erratic output behavior as their respective thresholds are crossed. The $V_{CC}$ comparator upper and lower thresholds are 16 V/10 V for the X842, and 8.4 V/7.6 V for the X843. The $V_{ref}$ comparator upper and lower thresholds are 3.6 V/3.4 V. The large hysteresis and low startup current of the X842 makes it ideally suited in off−line converter applications where efficient bootstrap startup techniques are required (Figure 35). The X843 is intended for lower voltage DC−to−DC converter applications. A 36 V Zener is connected as a shunt regulator from $V_{CC}$ to ground. Its purpose is to protect the IC from excessive voltage that can occur during system startup. The minimum operating voltage ($V_{CC}$) for the X842 is 11 V and 8.2 V for the X843.

These devices contain a single totem pole output stage that was specifically designed for direct drive of power MOSFETs. It is capable of up to ±1.0 A peak drive current and has a typical rise and fall time of 50 ns with a 1.0 nF load. Additional internal circuitry has been added to keep the Output in a sinking mode whenever an undervoltage lockout is active. This characteristic eliminates the need for an external pull−down resistor.

The SOIC−14 surface mount package provides separate pins for $V_C$ (output supply) and Power Ground. Proper implementation will significantly reduce the level of switching transient noise imposed on the control circuitry. This becomes particularly useful when reducing the $I_{pk(max)}$ clamp level. The separate $V_C$ supply input allows the designer added flexibility in tailoring the drive voltage independent of $V_{CC}$. A Zener clamp is typically connected to this input when driving power MOSFETs in systems where $V_{CC}$ is greater than 20 V. Figure 27 shows proper power and control ground connections in a current−sensing power MOSFET application.

**Reference**

The 5.0 V bandgap reference is trimmed to ±1.0% tolerance at $T_J = 25°C$ on the 284X, and ±2.0% on the 384X. Its primary purpose is to supply charging current to the oscillator timing capacitor. The reference has short−circuit protection and is capable of providing in excess of 20 mA for powering additional control system circuitry.

**Design Considerations**

**Do not attempt to construct the converter on wire−wrap or plug−in prototype boards.** High frequency circuit layout techniques are imperative to prevent pulse−width jitter. This is usually caused by excessive noise pick−up imposed on the Current Sense or Voltage Feedback inputs. Noise immunity can be improved by lowering circuit impedances at these points. The printed circuit layout should contain a ground plane with low−current signal and high−current switch and output grounds returning on separate paths back to the input filter capacitor. Ceramic bypass capacitors (0.1 μF) connected directly to $V_{CC}$, $V_C$, and $V_{ref}$ may be required depending upon circuit layout. This provides a low impedance path for filtering the high frequency noise. All high current loops should be kept as short as possible using heavy copper runs to minimize radiated EMI. The Error Amp compensation circuitry and the converter output voltage divider should be located close to the IC and as far as possible from the power switch and other noise−generating components.

Current mode converters can exhibit subharmonic oscillations when operating at a duty cycle greater than 50% with continuous inductor current. This instability is independent of the regulator's closed loop characteristics and is caused by the simultaneous operating conditions of fixed frequency and peak current detecting. Figure 21A shows the phenomenon graphically. At $t_0$, switch conduction begins, causing the inductor current to rise at a slope of $m_1$. This slope is a function of the input voltage divided by the inductance. At $t_1$, the Current Sense Input reaches the threshold established by the control voltage. This causes the switch to turn off and the current to decay at a slope of $m_2$, until the next oscillator cycle. The unstable condition can be shown if a perturbation is added to the control voltage, resulting in a small $\Delta I$ (dashed line). With a fixed oscillator period, the current decay time is reduced, and the minimum current at switch turn−on ($t_2$) is increased by $\Delta I + \Delta I\, m_2/m_1$. The minimum current at the next cycle ($t_3$) decreases to $(\Delta I + \Delta I\, m_2/m_1)\,(m_2/m_1)$. This perturbation is multiplied by $m_2/m_1$ on each succeeding cycle, alternately increasing and decreasing the inductor current at switch turn−on. Several oscillator cycles may be required before the inductor current reaches zero causing the process to commence again. If $m_2/m_1$ is greater than 1, the converter will be unstable. Figure 21B shows that by adding an artificial ramp that is synchronized with the PWM clock to the control voltage, the $\Delta I$ perturbation will decrease to zero on succeeding cycles. This compensating ramp ($m_3$) must have a slope equal to or slightly greater than $m_2/2$ for stability. With $m_2/2$ slope compensation, the average inductor current follows the control voltage, yielding true current mode operation. The compensating ramp can be derived from the oscillator and added to either the Voltage Feedback or Current Sense inputs (Figure 34).
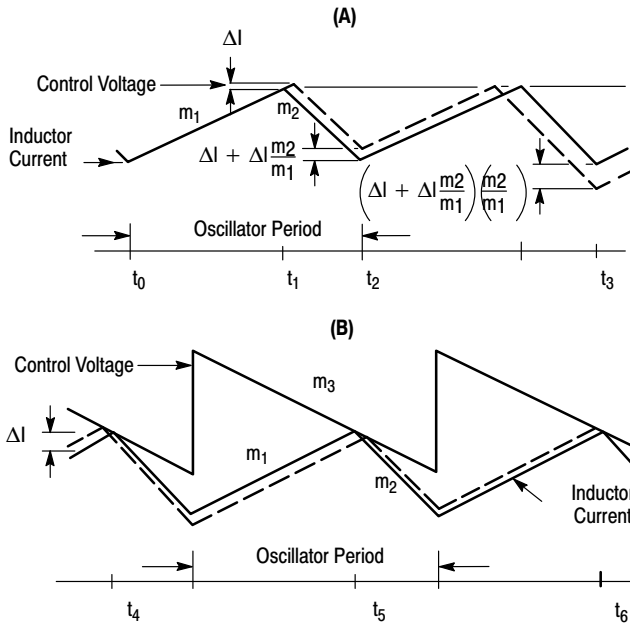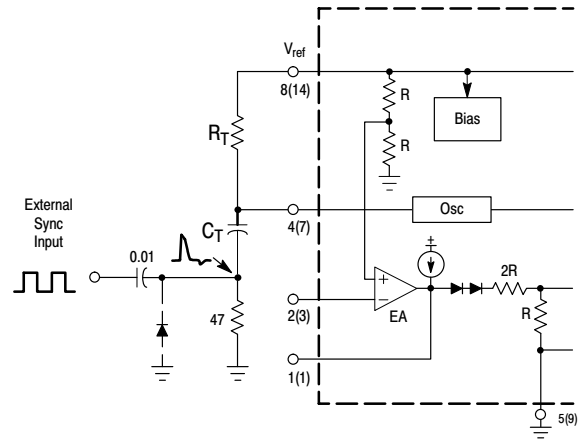
**Figure 21. Continuous Current Waveforms**



The diode clamp is required if the Sync amplitude is large enough to cause the bottom side of $C_T$ to go more than 300 mV below ground.
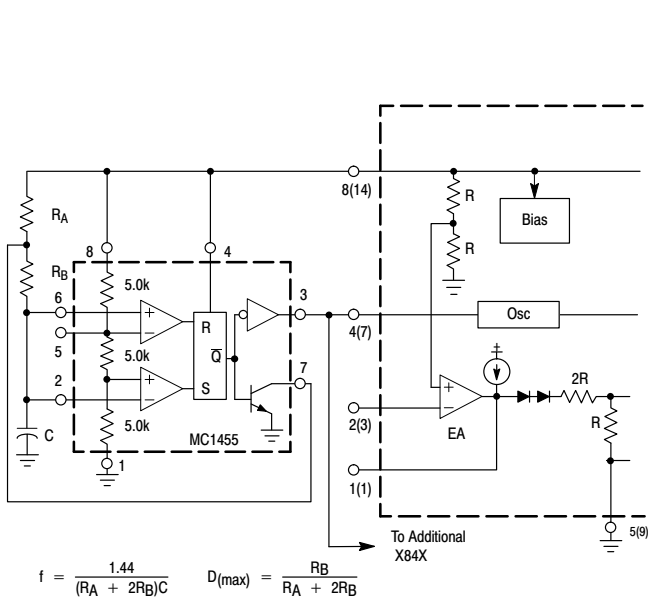
**Figure 22. External Clock Synchronization**



$$f = \frac{1.44}{(R_A + 2R_B)C} \qquad D_{(max)} = \frac{R_B}{R_A + 2R_B}$$

**Figure 23. External Duty Cycle Clamp and Multi−Unit Synchronization**



$$V_{Clamp} \approx \frac{1.67}{\left(\frac{R_2}{R_1} + 1\right)} + 0.33 \times 10^{-3} \left(\frac{R_1 R_2}{R_1 + R_2}\right) \qquad \text{Where: } 0 \le V_{Clamp} \le 1.0\text{ V}$$
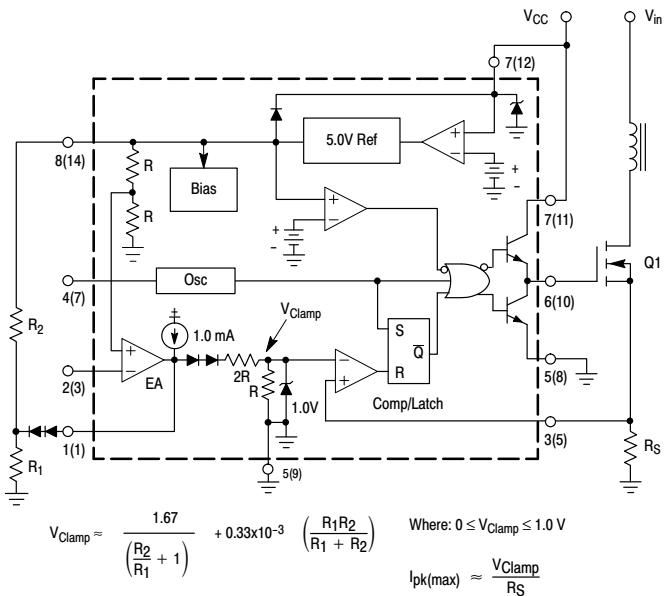
$$I_{pk(max)} \approx \frac{V_{Clamp}}{R_S}$$

**Figure 24. Adjustable Reduction of Clamp Level**
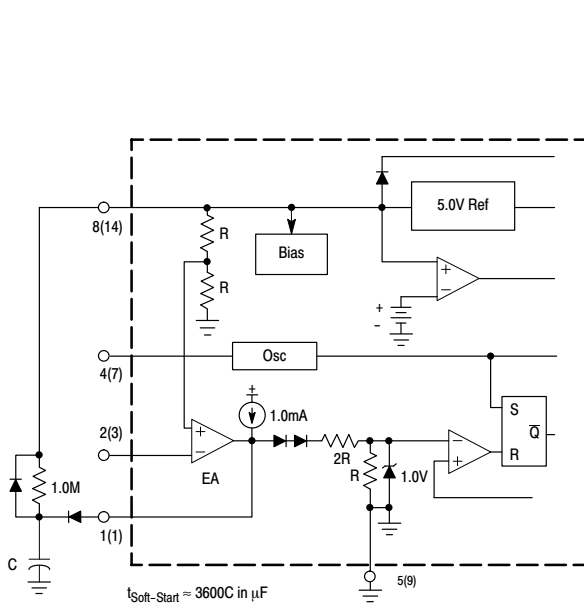
**Figure 25. Soft−Start Circuit**

$$t_{Soft-Start} \approx 3600C \text{ in } \mu F$$



$$V_{Clamp} \approx \frac{1.67}{\left(\frac{R_2}{R_1} + 1\right)} \qquad \text{Where: } 0 \le V_{Clamp} \le 1.0 \text{ V}$$

$$t_{SoftStart} = -\ln\left[1 - \frac{VC}{3\,V_{Clamp}}\right] C \frac{R_1\,R_2}{R_1 + R_2} \qquad I_{pk(max)} \approx \frac{V_{Clamp}}{R_S}$$

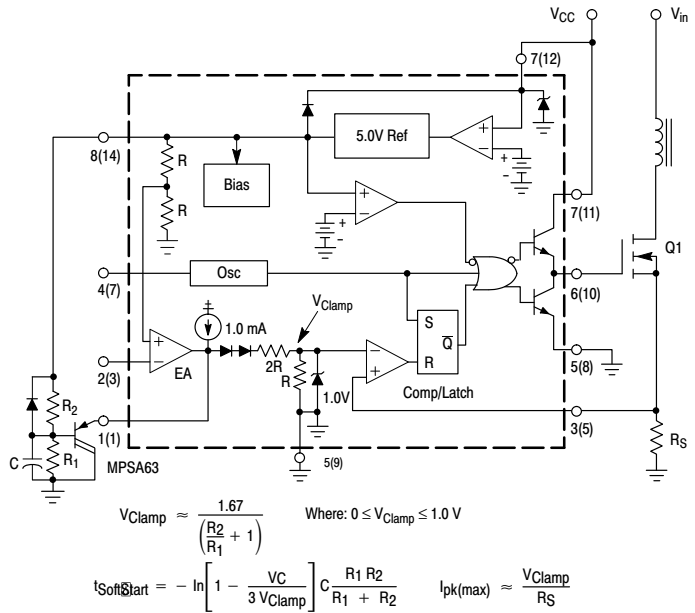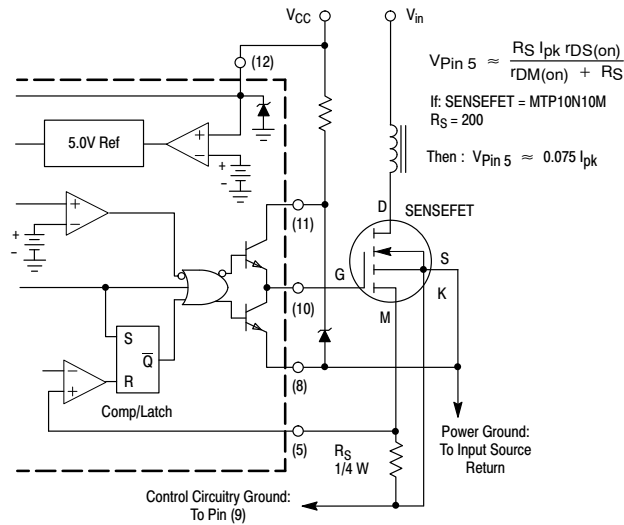**Figure 26. Adjustable Buffered Reduction of Clamp Level with Soft−Start**



$$V_{Pin\,5} \approx \frac{R_S\,I_{pk}\,r_{DS(on)}}{r_{DM(on)} + R_S}$$

If: SENSEFET = MTP10N10M
$R_S = 200$

Then : $V_{Pin\,5} \approx 0.075\,I_{pk}$

Virtually lossless current sensing can be achieved with the implementation of a SENSEFET power switch. For proper operation during over−current conditions, a reduction of the $I_{pk(max)}$ clamp level must be implemented. Refer to Figures 24 and 26.

**Figure 27. Current Sensing Power MOSFET**
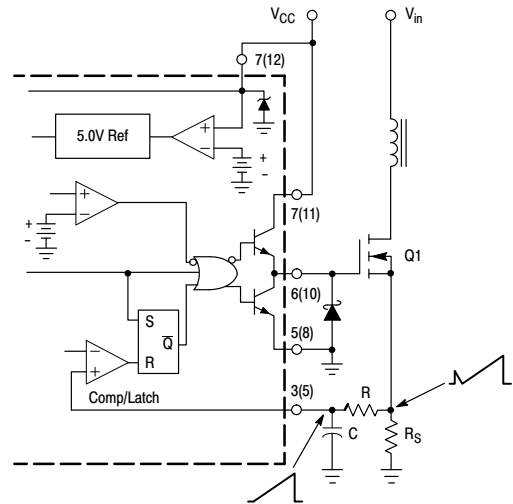


The addition of the RC filter will eliminate instability caused by the leading edge spike on the current waveform.

**Figure 28. Current Waveform Spike Suppression**
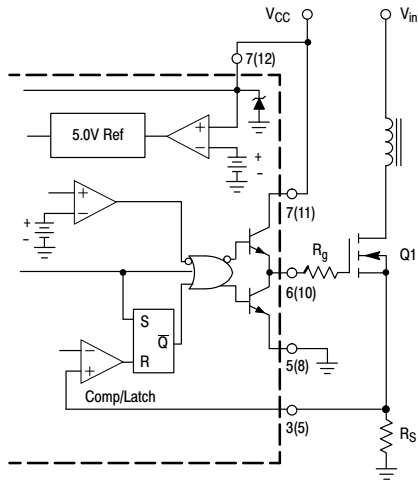
Series gate resistor $R_g$ will damp any high frequency parasitic oscillations caused by the MOSFET input capacitance and any series wiring inductance in the gate–source circuit.

**Figure 29. MOSFET Parasitic Oscillations**
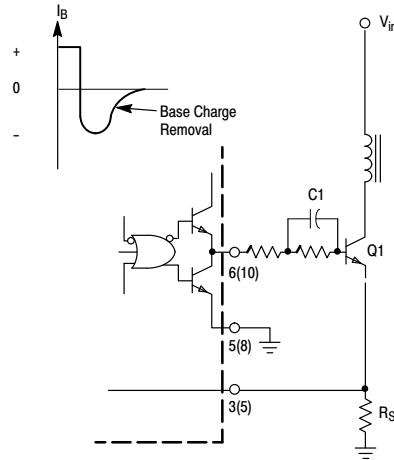
The totem pole output can furnish negative base current for enhanced transistor turn–off, with the addition of capacitor $C_1$.

**Figure 30. Bipolar Transistor Drive**

$$I_{pk} = \frac{V(Pin1) - 1.4}{3\,R_S}\left(\frac{N_S}{N_P}\right)$$
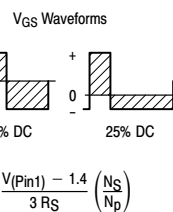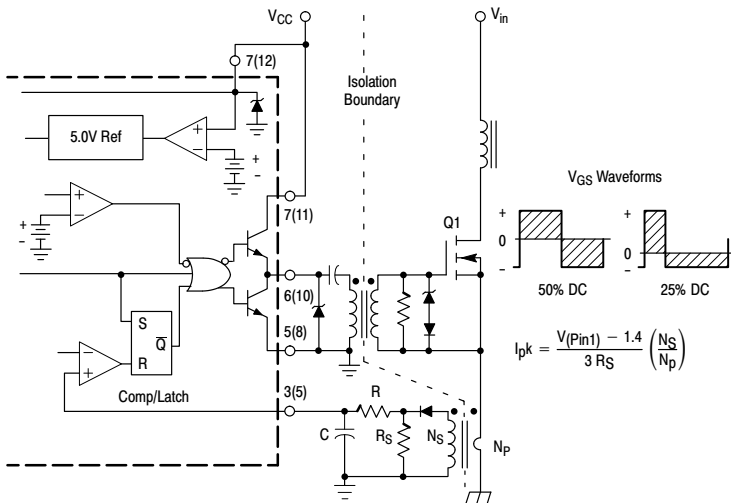
**Figure 31. Isolated MOSFET Drive**
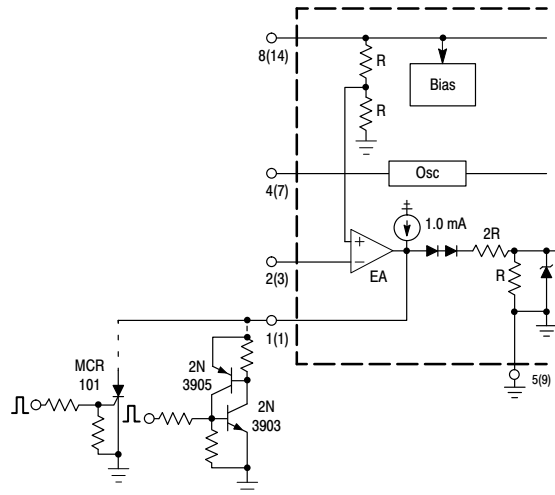
The MCR101 SCR must be selected for a holding of < 0.5 mA @ $T_{A(min)}$. The simple two transistor circuit can be used in place of the SCR as shown. All resistors are 10 k.

**Figure 32. Latched Shutdown**

Error Amp compensation circuit for stabilizing any current mode topology except for boost and flyback converters operating with continuous inductor current.



Error Amp compensation circuit for stabilizing current mode boost and flyback topologies operating with continuous inductor current.

**Figure 33. Error Amplifier Compensation**



The buffered oscillator ramp can be resistively summed with either the voltage feedback or current sense inputs to provide slope compensation.

**Figure 34. Slope Compensation**

**Figure 35. 27 W Off−Line Flyback Regulator**

L1 – 15 μH at 5.0 A, Coilcraft Z7156
L2, L3 – 25 μH at 5.0 A, Coilcraft Z7157

T1 – Primary: 45 Turns #26 AWG
Secondary ±12 V: 9 Turns #30 AWG
(2 Strands) Bifiliar Wound
Secondary 5.0 V: 4 Turns (six strands)
#26 Hexfiliar Wound
Secondary Feedback: 10 Turns
#30 AWG (2 strands) Bifiliar Wound
Core: Ferroxcube EC35−3C8
Bobbin: Ferroxcube EC35PCB1
Gap: ≈ 0.10" for a primary inductance
of 1.0 mH

| Test | Conditions | Results |
|---|---|---|
| Line Regulation: 5.0 V<br>±12 V | $V_{in}$ = 95 to 130 Vac | Δ = 50 mV or ± 0.5%<br>Δ = 24 mV or ± 0.1% |
| Load Regulation: 5.0 V<br><br>±12 V | $V_{in}$ = 115 Vac,<br>$I_{out}$ = 1.0 A to 4.0 A<br>$V_{in}$ = 115 Vac,<br>$I_{out}$ = 100 mA to 300 mA | Δ = 300 mV or ± 3.0%<br><br>Δ = 60 mV or ± 0.25% |
| Output Ripple: 5.0 V<br>±12 V | $V_{in}$ = 115 Vac | 40 mV$_{pp}$<br>80 mV$_{pp}$ |
| Efficiency | $V_{in}$ = 115 Vac | 70% |

All outputs are at nominal load currents, unless otherwise noted

## PACKAGE DIMENSIONS

**PDIP−8**
**N SUFFIX**
CASE 626−05
ISSUE N



**TOP VIEW**

**END VIEW**
**WITH LEADS CONSTRAINED**
**NOTE 5**

**SIDE VIEW**

$\bigoplus$ | 0.010 Ⓜ | C | A Ⓜ | B Ⓜ

**END VIEW**
**NOTE 6**
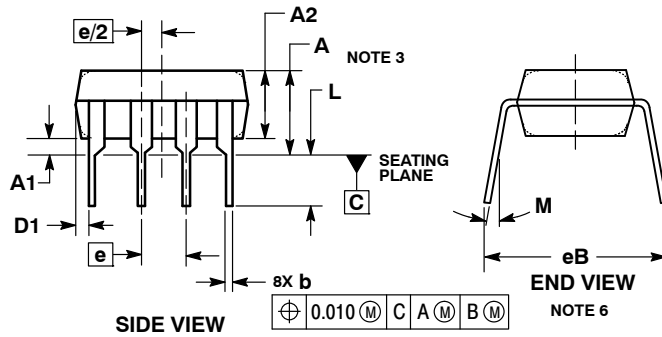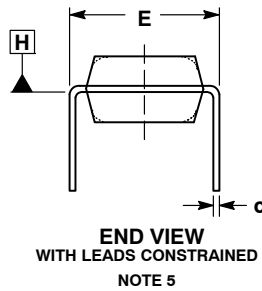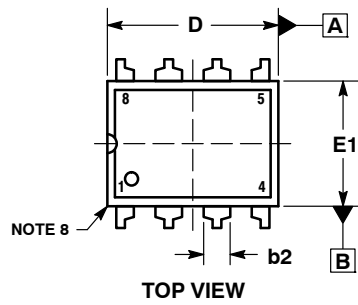
NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACK-AGE SEATED IN JEDEC SEATING PLANE GAUGE GS−3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

| DIM | INCHES | | MILLIMETERS | |
|---|---|---|---|---|
| | MIN | MAX | MIN | MAX |
| A | ---- | 0.210 | --- | 5.33 |
| A1 | 0.015 | ---- | 0.38 | --- |
| A2 | 0.115 | 0.195 | 2.92 | 4.95 |
| b | 0.014 | 0.022 | 0.35 | 0.56 |
| b2 | 0.060 TYP | | 1.52 TYP | |
| C | 0.008 | 0.014 | 0.20 | 0.36 |
| D | 0.355 | 0.400 | 9.02 | 10.16 |
| D1 | 0.005 | | 0.13 | |
| E | 0.300 | 0.325 | 7.62 | 8.26 |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 |
| e | 0.100 BSC | | 2.54 BSC | |
| eB | ---- | 0.430 | --- | 10.92 |
| L | 0.115 | 0.150 | 2.92 | 3.81 |
| M | ---- | 10° | --- | 10° |

## PACKAGE DIMENSIONS

**SOIC−8**
**D1 SUFFIX**
CASE 751−07
ISSUE AK
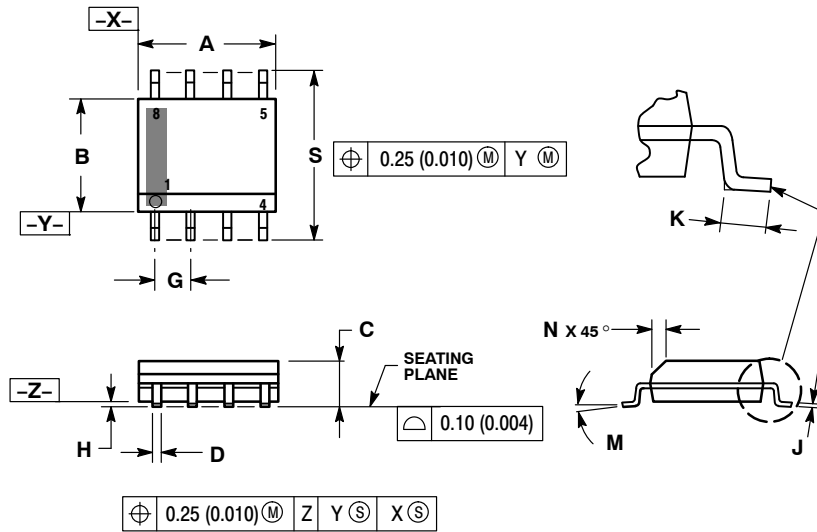
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751−01 THRU 751−06 ARE OBSOLETE. NEW STANDARD IS 751−07.

| DIM | MILLIMETERS | | INCHES | |
|-----|-----|-----|-----|-----|
| | MIN | MAX | MIN | MAX |
| A | 4.80 | 5.00 | 0.189 | 0.197 |
| B | 3.80 | 4.00 | 0.150 | 0.157 |
| C | 1.35 | 1.75 | 0.053 | 0.069 |
| D | 0.33 | 0.51 | 0.013 | 0.020 |
| G | 1.27 BSC | | 0.050 BSC | |
| H | 0.10 | 0.25 | 0.004 | 0.010 |
| J | 0.19 | 0.25 | 0.007 | 0.010 |
| K | 0.40 | 1.27 | 0.016 | 0.050 |
| M | 0 ° | 8 ° | 0 ° | 8 ° |
| N | 0.25 | 0.50 | 0.010 | 0.020 |
| S | 5.80 | 6.20 | 0.228 | 0.244 |

以上信息仅供参考. 如需帮助联系客服人员。谢谢 XINLUDA